



### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON) MAX</sub> I <sub>D</sub> T <sub>C</sub> = +25°C	
-40V	$11m\Omega @ V_{GS} = -10V$	-74A
-40 V	19mΩ @ $V_{GS}$ = -4.5V	-55A

## Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Backlighting

## P-CHANNEL ENHANCEMENT MODE MOSFET

## **Features and Benefits**

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMP4011SK3Q</u>)

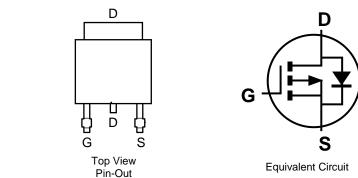
## **Mechanical Data**

- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)



Top View

TO252 (DPAK)



## Ordering Information (Note 4)

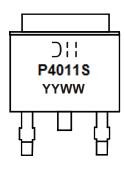
Part Number	Case	Packaging
DMP4011SK3-13	TO252 (DPAK)	2,500/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



Dif = Manufacturer's Marking P4011S = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 19 = 2019) WW = Week (01 to 53)



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	-40	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Dusin Current (Nata C) // 40//	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	ID	-74 -59	A
Continuous Drain Current (Note 6) $V_{GS} = -10V$	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	-14 -11	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-200	A		
Maximum Body Diode Forward Current (Note 6)	Is	-70	A		
ulsed Source Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	-200	A	
Avalanche Current, L = 1mH (Note 7)			I <sub>AS</sub>	-22	A
Avalanche Energy, L = 1mH (Note 7)			E <sub>AS</sub>	250	mJ

# Thermal Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	84	°C/W
Total Power Dissipation (Note 6)		PD	3.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	41	°C/W
Thermal Resistance, Junction to Case		$R_{\theta JC}$	1.4	C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)			•			÷
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40	_	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	—	-1	μA	$V_{DS} = -32V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	-2.0	-2.5	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance	P	_	6.5	11		$V_{GS} = -10V, I_D = -9.8A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		10.8	19	mΩ	$V_{GS} = -4.5V, I_D = -9.8A$
Diode Forward Voltage	V <sub>SD</sub>	_	-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		2747	—		V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V f = 1MHz
Output Capacitance	Coss		508	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>		222	—		
Gate Resistance	Rg	_	21.4	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	25	_		
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	52	-	nC	V <sub>DS</sub> = -20V, I <sub>D</sub> = -9.8A
Gate-Source Charge	Q <sub>gs</sub>	_	8.5	_	nc	
Gate-Drain Charge	Q <sub>gd</sub>		11.8	_		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	6.6	_		
Turn-On Rise Time	t <sub>R</sub>		6.5	_	20	$\label{eq:VGS} \begin{array}{l} V_{GS} = \texttt{-10V}, \ V_{DD} = \texttt{-20V}, \\ R_{G} = 6\Omega, \ I_{D} = \texttt{-1A} \end{array}$
Turn-Off Delay Time	t <sub>D(OFF)</sub>		222	_	ns	
Turn-Off Fall Time	t <sub>F</sub>		138	_		
Reverse Recovery Time	t <sub>RR</sub>		25	_	ns	I <sub>F</sub> = -9.8A, di/dt = -100A/µs
Reverse Recovery Charge	Q <sub>RR</sub>	_	17	_	nC	I <sub>F</sub> = -9.8A, di/dt = -100A/µs

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

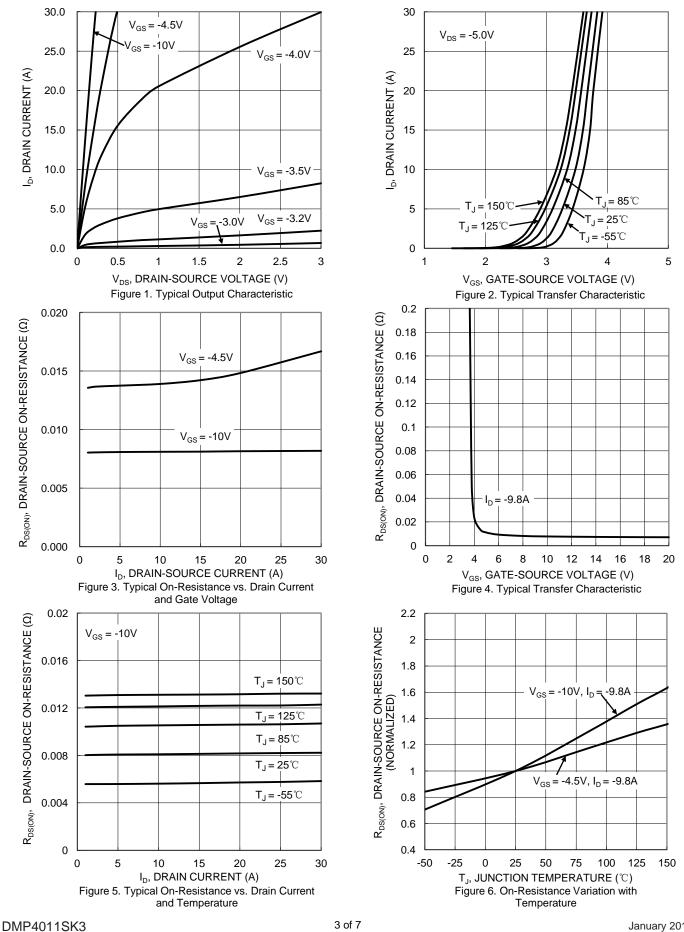
7. I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



## DMP4011SK3

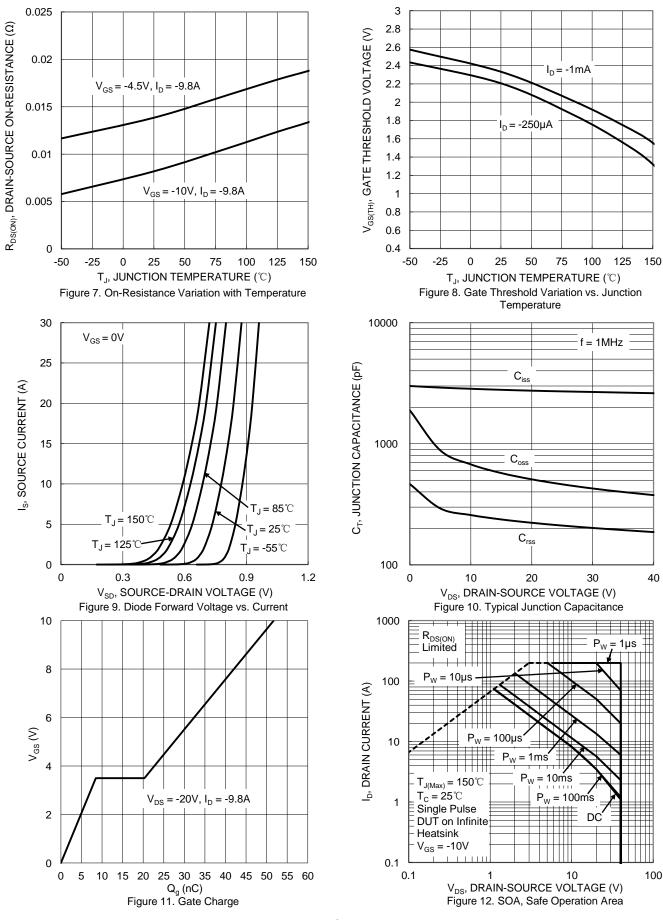


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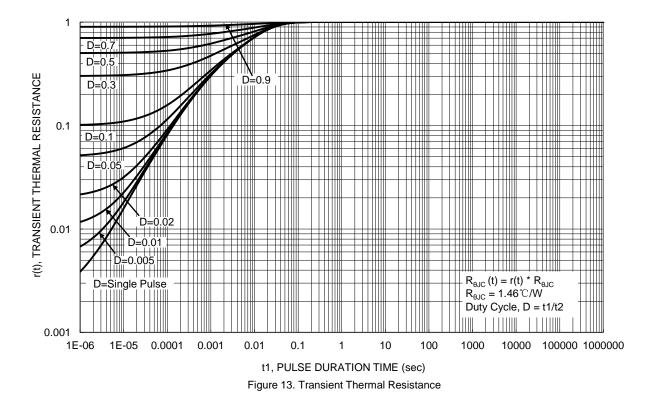
## DMP4011SK3



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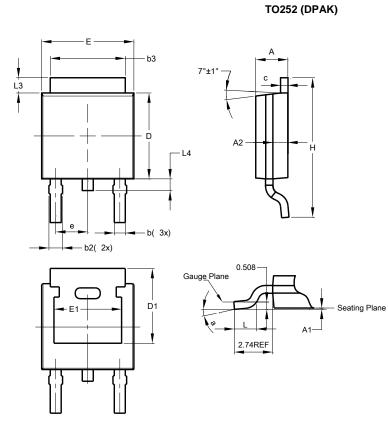


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# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

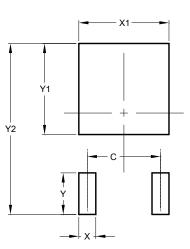


	TO252 (DPAK)					
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	-	-			
е	-	-	2.286			
Ε	6.45	6.70	6.58			
E1	4.32	-	-			
Н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All	All Dimensions in mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700



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